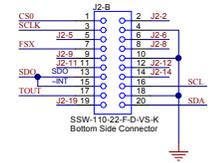
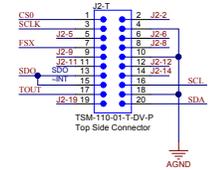
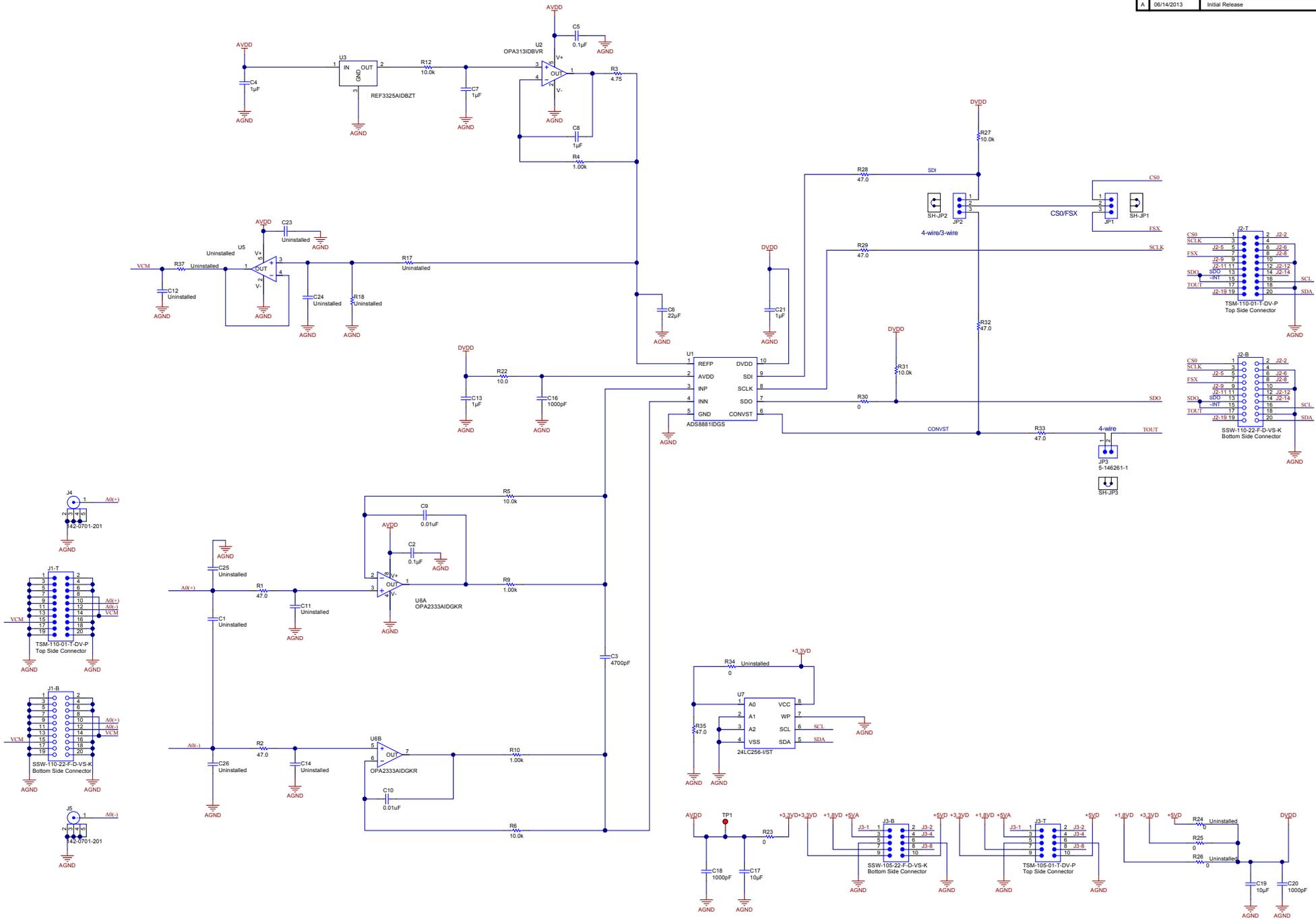


Revision History	
Date	Notes
A 06/14/2013	Initial Release



DRAFTSMAN B.McKay	DATE 06/14/2013	DESIGNER B.McKay	DATE 06/14/2013	CHECKER B.McKay	DATE 06/14/2013	ENGINEER B.McKay	DATE 06/14/2013	APPROVED B.McKay	DATE 06/14/2013	RELEASED B.McKay	DATE 06/14/2013	
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